

**Supplemental Application Data Sheet****Application Information**

<b>Application number::</b>	10/526,745
<b>Filing Date::</b>	03/07/2005
<b>Application Type::</b>	Regular
<b>Subject Matter::</b>	Utility
<b>CD-ROM or CD-R?::</b>	None
<b>Computer Readable Form (CRF)?::</b>	No
<b>Title::</b>	METHOD OF FORMING THIN FILM ON BASE SUBSTANCE VIA INTERMEDIATE LAYER
<b>Attorney Docket Number::</b>	017700-0174
<b>Request for Early Publication?::</b>	No
<b>Request for Non-Publication?::</b>	No
<b>Suggested Drawing Figure::</b>	3
<b>Total Drawing Sheets::</b>	3A, 3B
<b>Small Entity?::</b>	No
<b>Petition included?::</b>	No
<b>Secrecy Order in Parent Appl.?::</b>	No

**Applicant Information**

<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	Japan
<b>Status::</b>	Full Capacity
<b>Given Name::</b>	Katsuya
<b>Family Name::</b>	HASEGAWA
<b>City of Residence::</b>	Osaka-shi, Osaka
<b>Country of Residence::</b>	Japan

<b>Street of mailing address::</b>	c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku
<b>City of mailing address::</b>	Osaka-shi
<b>State or Province of mailing address::</b>	Osaka
<b>Country of mailing address::</b>	Japan
<b>Postal or Zip Code of mailing address::</b>	554-8511
<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	Japan
<b>Status::</b>	Full Capacity
<b>Given Name::</b>	Teruo
<b>Family Name::</b>	IZUMI
<b>City of Residence::</b>	Koto-ku, Tokyo
<b>Country of Residence::</b>	Japan
<b>Street of mailing address::</b>	c/o Superconductivity <u>Research Laboratory</u> <u>International Superconductivity</u> Technology Center, The Juridical Foundation 10-13, Shinonome 1-chome
<b>City of mailing address::</b>	Koto-ku
<b>State or Province of mailing address::</b>	Tokyo
<b>Country of mailing address::</b>	Japan
<b>Postal or Zip Code of mailing address::</b>	135-0062
<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	Japan
<b>Status::</b>	Full Capacity
<b>Given Name::</b>	Yuh
<b>Family Name::</b>	SHIOHARA
<b>City of Residence::</b>	Koto-ku, Tokyo

**Country of Residence::** Japan  
**Street of mailing address::** c/o Superconductivity Research Laboratory  
International Superconductivity Technology Center,  
The Juridical Foundation  
10-13, Shinonome 1-chome  
**City of mailing address::** Koto-ku  
**State or Province of mailing address::** Tokyo  
**Country of mailing address::** Japan  
**Postal or Zip Code of mailing address::** 135-0062

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** Japan  
**Status::** Full Capacity  
**Given Name::** Yoshihiro  
**Family Name::** SUGAWARA  
**City of Residence::** Nagoya-shi, Aichi  
**Country of Residence::** Japan  
**Street of mailing address::** c/o Japan Fine Ceramics Center  
4-1, Mutsuno 2-chome  
~~Atsuta-ku, Nagoya-shi~~  
**City of mailing address::** Nagoya-shi  
**State or Province of mailing address::** Aichi  
**Country of mailing address::** Japan  
**Postal or Zip Code of mailing address::** 456-8587

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** Japan  
**Status::** Full Capacity  
**Given Name::** Tsukasa  
**Family Name::** HIRAYAMA

**City of Residence::** Nagoya-shi, Aichi  
**Country of Residence::** Japan  
**Street of mailing address::** c/o Japan Fine Ceramics Center  
4-1, Mutsuno 2-chome  
Atsuta-ku, ~~Nagoya-shi~~  
**City of mailing address::** Nagoya-shi  
**State or Province of mailing address::** Aichi  
**Country of mailing address::** Japan  
**Postal or Zip Code of mailing address::** 456-8587

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** Japan  
**Status::** Full Capacity  
**Given Name::** Fumiyasu  
**Family Name::** OBA  
**City of Residence::** Kyoto-shi, Kyoto  
**Country of Residence::** Japan  
**Street of mailing address::** c/o Department of Materials Science and Engineering  
Kyoto University  
Yoshida-honmachi, Sakyo-ku  
**City of mailing address::** Kyoto-shi  
**State or Province of mailing address::** Kyoto  
**Country of mailing address::** Japan  
**Postal or Zip Code of mailing address::** 606-8501

**Applicant Authority Type::** Inventor  
**Primary Citizenship Country::** Japan  
**Status::** Full Capacity  
**Given Name::** Yuichi

**Family Name::** IKUHARA  
**City of Residence::** Bunkyo-ku, Tokyo  
**Country of Residence::** Japan  
**Street of mailing address::** c/o Institute of Engineering Innovation, The  
 University of Tokyo  
 2-11-16, Yayoi, ~~Bunkyo-ku~~  
**City of mailing address::** Bunkyo-ku  
**State or Province of mailing address::** Tokyo  
**Country of mailing address::** Japan  
**Postal or Zip Code of mailing address::** 113-8656

#### Correspondence Information

**Correspondence Customer Number::** 22428  
**E-Mail address::** PTOMailWashington@foley.com

#### Representative Information

<b>Representative Customer Number::</b>	22428	
---	-------	--

#### Domestic Priority Information

<b>Application::</b>	<b>Continuity Type::</b>	<b>Parent Application::</b>	<b>Parent Filing Date::</b>
This Application	National Stage of	PCT/JP03/13887	10/29/2003

#### Foreign Priority Information

<b>Country::</b>	<b>Application number::</b>	<b>Filing Date::</b>	<b>Priority Claimed::</b>

Japan	2002-318477	10/31/2002	Yes
-------	-------------	------------	-----

### **Assignee Information**

**Assignee Name::**

Sumitomo Electric Industries, Ltd.

**Assignee Name::**

The International Superconductivity  
Technology Center, The Juridical Foundation